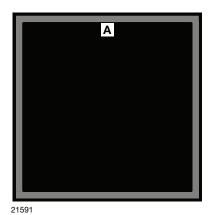
## Vishay Semiconductors

## Silicon PIN Photodiode



#### **DESCRIPTION**

T1610P6 is a high speed and high sensitive PIN photodiode chip with 7.7 mm<sup>2</sup> sensitive area. It is sensitive to visible light much like the human eye and has peak sensitivity at 560 nm. Anode is the bond pad on top, cathode is the backside contact.

#### **FEATURES**

- Package type: chip
- Package form: single chip





- Radiant sensitive area (in mm<sup>2</sup>): 7.7
- High photo sensitivity
- High sensitivity
- Suitable for visible light
- Fast response times
- Angle of half sensitivity:  $\varphi = \pm 60^{\circ}$
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>



GREEN

### **APPLICATIONS**

- · Ambient light sensor
- · Backlight dimmer

#### **GENERAL INFORMATION**

The datasheet is based on Vishay optoelectronics sample testing under certain predetermined and assumed conditions, and is provided for illustration purpose only. Customers are encouraged to perform testing in actual proposed packaged and used conditions. Vishay optoelectronics die products are tested using Vishay optoelectronics based quality assurance procedures and are manufactured using Vishay optoelectronics established processes. Estimates such as those described and set forth in this datasheet for semiconductor die will vary depending on a number of packaging, handling, use, and other factors. Therefore sold die may not perform on an equivalent basis to standard package products.

PRODUCT SUMMARY					
COMPONENT	I <sub>ra</sub> (μΑ)	φ <b>(°)</b>	λ <sub>0.5</sub> (nm)		
T1610P6	2.9	± 60	390 to 800		

## Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
T1610P6-SD-F	Wafer sawn on foil with disco frame	MOQ: 7800 pcs	Chip		

#### Note

MOQ: minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		$V_R$	16	V	
Junction temperature		Tj	100	°C	
Operating temperature range		T <sub>amb</sub>	-40 to +100	°C	
Storage temperature range		T <sub>stg1</sub>	-40 to +100	°C	
Storage temperature range on foil		T <sub>stg2</sub>	-40 to +50	°C	

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<b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Breakdown voltage	$I_R = 100 \ \mu A, \ E = 0$	V <sub>(BR)</sub>	16	-	-	V
Reverse dark current	$V_R = 10 V, E = 0$	I <sub>ro</sub>	-	2	5	nA
Diode capacitance	V <sub>R</sub> = 3 V, f = 1 MHz, E = 0	C <sub>D</sub>	-	730	-	pF
Reverse light current	$E_V = 100 \text{ lx}$ , CIE illuminant A, $V_R = 5 \text{ V}$	I <sub>ra</sub>	-	2.9	-	μΑ
Angle of half sensitivity		φ	-	± 60	-	٥
Wavelength of peak sensitivity		$\lambda_{p}$	-	560	-	nm
Range of spectral bandwidth		λ <sub>0.5</sub>	-	390 to 800	-	nm
Rise time	$V_R = 5 \text{ V}, R_L = 50 \Omega, \lambda = 515 \text{ nm}$	t <sub>r</sub>	-	100	-	ns
Fall time	$V_R = 5 \text{ V}, R_L = 50 \Omega, \lambda = 515 \text{ nm}$	t <sub>f</sub>	-	100	-	ns

#### Note

### **BASIC CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

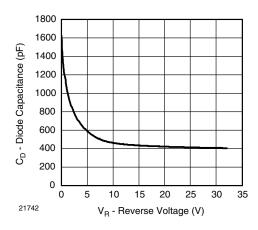


Fig. 1 - Diode Capacitance vs. Reverse Voltage

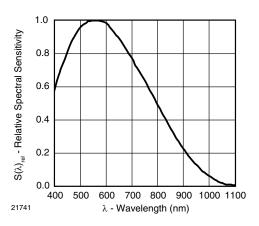


Fig. 2 - Relative Spectral Sensitivity vs. Wavelength

MECHANICAL DIMENSIONS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Length of chip edge (x-direction)	L <sub>x</sub>	-	2.97	-	mm
Length of chip edge (y-direction)	L <sub>y</sub>	-	2.97	-	mm
Sensitive area	As	-	7.7	-	mm <sup>2</sup>
Die height	Н	-	0.28	-	mm
Bond pad anode	x * v	-	0.125 x 0.11	-	mm <sup>2</sup>

ADDITIONAL INFORMATION			
Frontside metallization, anode	AlSi		
Backside metallization, cathode	NiV-Ag		
Dicing	Sawing		
Die bonding technology	Epoxy bonding		

#### Note

All chips are checked in accordance with the Vishay Semiconductor, specification of visual inspection FVOV6870.
 The visual inspection shall be made in accordance with the "specification of visual inspection as referenced". The visual inspection of chip backside is performed with stereo microscope with incident light and 40x to 80x magnification.
 The quality inspection (final visual inspection) is performed by production. An additional visual inspection step as special release procedure by QM is not installed

<sup>•</sup> The measurements are based on samples of die which are mounted on a TO-header without resin coating



# Vishay Semiconductors

### HANDLING AND STORAGE CONDITIONS

- The hermetically sealed shipment lots shall be opened in temperature and moisture controlled cleanroom environment only. It is mandatory to follow the rules for disposition of material that can be hazardous for humans and environment.
- Product must be handled only at ESD safe workstations. Standard ESD precautions and safe work environments are as defined in MIL-HDBK-263.
- Singulated die are not to be handled with tweezers. A vacuum wand with non metallic ESD protected tip should be used.

#### **PACKING**

Chips are fixed on adhesive foil. Upon request the foils can be mounted on plastic frame or disco frame. For shipment, the wafers are arranged to stacks and hermetically sealed in plastic bags to ensure protection against environmental influence (humidity and contamination).

Use for recycling reliable operators only. We can help getting in touch with your nearest sales office. By agreement we will take back packing material, if it is sorted. You will have to bear the costs of transport. We will invoice you for any costs incurred for packing material that is returned unsorted or which we are not obliged to accept.



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Vishay

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